

## Capacitive Controller ICs

# Capacitive Switch Controller IC

### BU21077MUV

#### General Description

BU21077MUV is a capacitive switch controller for switch operation.

BU21077MUV has programmable MPU and it control the sensing sequence and how to use value of sensor. It is possible to reduce operational current with devising a sensing sequence.

#### Key Specifications

- Input Voltage Range 2.7 to 5.5V
- Operating Temperature Range -20 to +85°C

#### Package

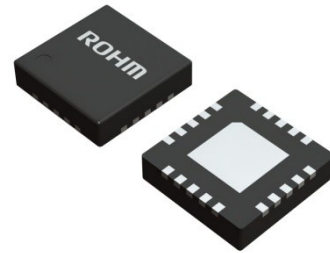
VQFN020V4040 4.00 mm×4.00 mm×1.00 mm

#### Features

- Programmable MPU
- 8 Capacitive Sensor Ports
- 2-Wire Serial Bus Interface
- Single Power Supply
- Built-in Power-On-Reset and Oscillator

#### Applications

- Portable Device such as Smart Phone, PDA.
- Electronic Device with Multi Switches
- Information Appliance such as Projector
- AV Appliance such as Digital TV, HDD Recorder
- PC / PC Peripheral Equipment such as Laptop PC



#### Typical Application Circuit

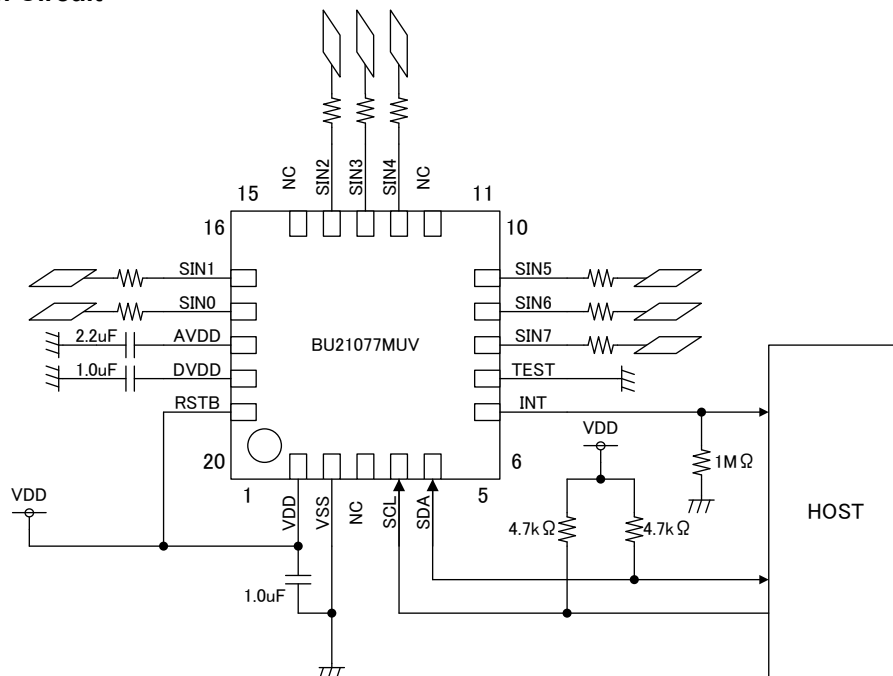


Figure 1. Typical Application Circuit

## Pin Configurations

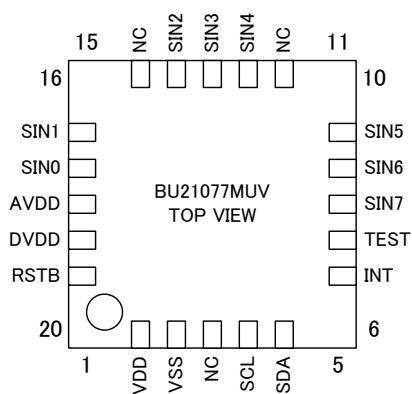


Figure 2. Pin Configurations

## Pin Descriptions

Pin No.	Pin Name	I/O	Functions	Note	Power	Initial Condition	I/O Equivalent Circuit
1	VDD	Power	Power		-	-	-
2	VSS	Ground	Ground		-	-	-
3	NC	-	-		-	-	-
4	SCL	In	Host-I/F SCL pin		VDD	Hi-Z	b
5	SDA	InOut	Host-I/F SDA pin		VDD	Hi-Z	b
6	INT	Out	Interrupt output		VDD	Hi-Z	b
7	TEST	In	Test input	Fix 'L' at the normal operation	VDD	Hi-Z	c
8	SIN7	InOut	Sensor 7		AVDD	Hi-Z	a
9	SIN6	InOut	Sensor 6		AVDD	Hi-Z	a
10	SIN5	InOut	Sensor 5		AVDD	Hi-Z	a
11	NC	-	-		-	-	-
12	SIN4	InOut	Sensor 4		AVDD	Hi-Z	a
13	SIN3	InOut	Sensor 3		AVDD	Hi-Z	a
14	SIN2	InOut	Sensor 2		AVDD	Hi-Z	a
15	NC	-	-		-	-	-
16	SIN1	InOut	Sensor 1		AVDD	Hi-Z	a
17	SIN0	InOut	Sensor 0		AVDD	Hi-Z	a
18	AVDD	Power	LDO output for analog blocks		-	-	-
19	DVDD	Power	LDO output for digital blocks		-	-	-
20	RSTB	In	Reset bar input	Active 'L'	VDD	Hi-Z	c

## I/O Equivalent Circuits

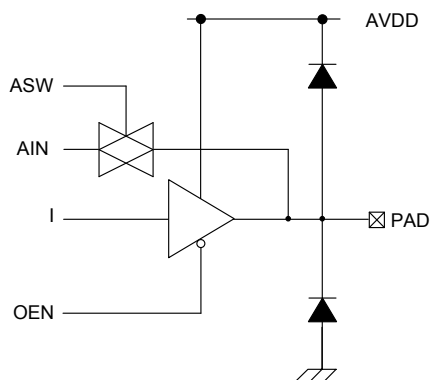


Figure 3. I/O Equivalent Circuit (a)

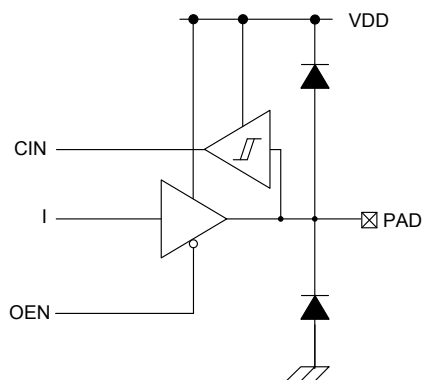


Figure 4. I/O Equivalent Circuit (b)

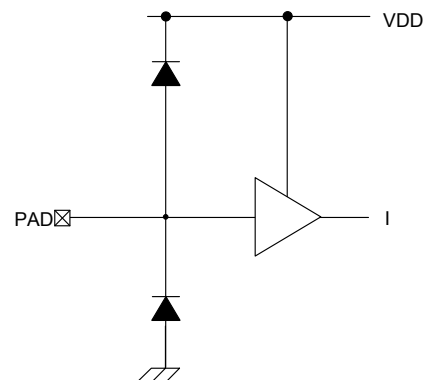


Figure 5. I/O Equivalent Circuit (c)

## Block Diagram

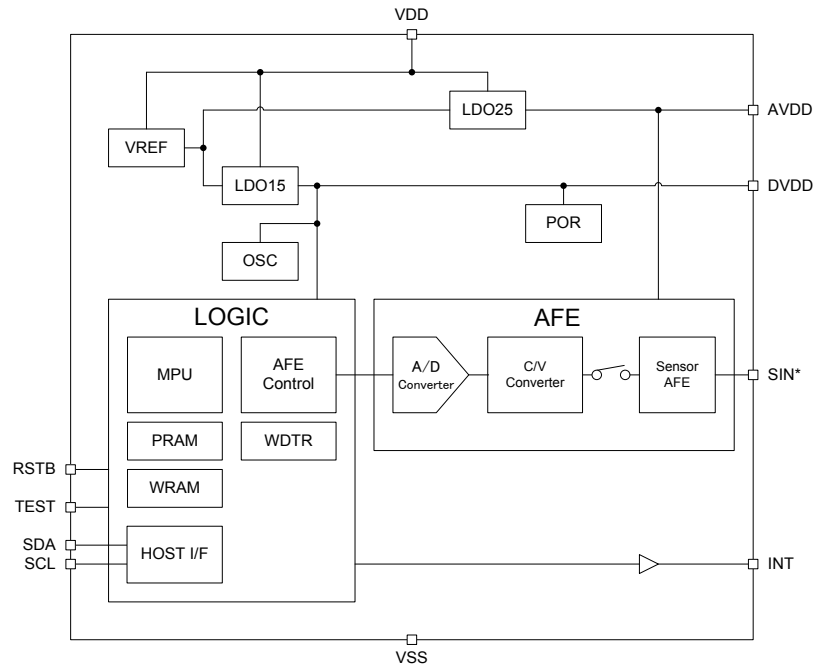


Figure 6. Block Diagram

## Description of Blocks

- Sensor AFE, C/V Converter  
Convert from capacitance to voltage for each sensor.
- A/D Converter  
Convert from analog value to digital value.
- LDO25  
2.5V output LDO for Sensor AFE, C/V Converter, and A/D converter.
- LDO15  
1.5V output LDO for OSC and Logic blocks.
- OSC  
Oscillator.
- POR  
Power-On-Reset for system reset.
- MPU  
Control sensor and sequence by program.
- PRAM  
8kbyte Program RAM of MPU. It needs to download program from host.
- WRAM  
Working RAM for MPU.
- HOST I/F  
2-wire serial bus interface compatible with I2C protocol.
- AFE Control  
Control sequencer for Sensor AFE, C/V Converter, and A/D Converter.
- WDTR  
Watchdog timer reset. It issues a reset when the MPU is hang-upped.

**Absolute Maximum Ratings**

(Ta = 25°C)

Parameter	Symbol	Rating	Unit
Power Supply Voltage	VDD	-0.5 to +7.0	V
Input Voltage	V <sub>IN</sub>	-0.5 to VDD + 0.3	V
Operating Temperature Range	T <sub>opr</sub>	-20 to +85	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +125	°C
Power Dissipation	P <sub>d</sub>	0.55 (Note 1)	W
Maximum Junction Temperature	T <sub>jmax</sub>	125	°C

(Note 1) Derate by 5.5mW/°C when operating above Ta=25°C (mounted in 1-layer 74.2×74.2×1.6mm board with 10.22mm<sup>2</sup> surface copper area)P<sub>d</sub> of IC is 0.27W and derate by 2.7mW/°C when operating above Ta=25°C.**Caution:** Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins and the internal circuitry. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.**Recommended Operating Condition**

(Ta = -20 to +85°C)

Parameter	Symbol	Rating	Unit
Power Supply Voltage	VDD	2.7 to 5.5	V

**Electrical Characteristics**

(Ta = 25°C, VDD = 3.3V, VSS = 0V)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Input High Voltage	V <sub>IH</sub>	VDD × 0.7	-	VDD + 0.3	V	
Input Low Voltage	V <sub>IL</sub>	VSS - 0.3	-	VDD × 0.3	V	
Output High Voltage	V <sub>OH</sub>	VDD - 0.5	-	VDD	V	I <sub>OH</sub> = -4mA
Output Low Voltage	V <sub>OL</sub>	VSS	-	VSS + 0.5	V	I <sub>OL</sub> = +4mA
OSC Frequency 1	f <sub>OSC1</sub>	45	50	55	MHz	
OSC Frequency 2	f <sub>OSC2</sub>	51.2	64	76.8	kHz	
DVDD Voltage	V <sub>DVDD</sub>	1.35	1.50	1.65	V	
AVDD Voltage	V <sub>AVDD</sub>	2.40	2.50	2.60	V	

## Host Interface

BU21077MUV has 2-wire serial bus interface. It is compatible with I2C protocol and BU21077MUV is a slave device. Slave address of BU21077MUV is 5Ch (Shown 7-bit). And it supports Standard-mode (100 KHz) and Fast-mode (400 kHz). It has sequential read for reduce access time.

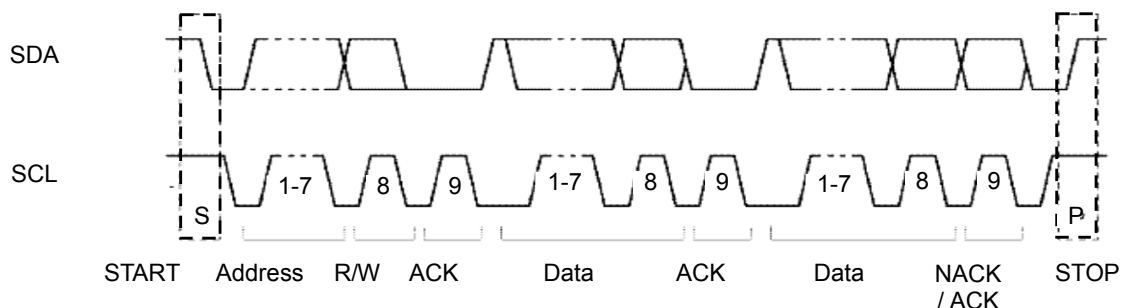


Figure 7. 2-wire Serial Bus Interface Data Format

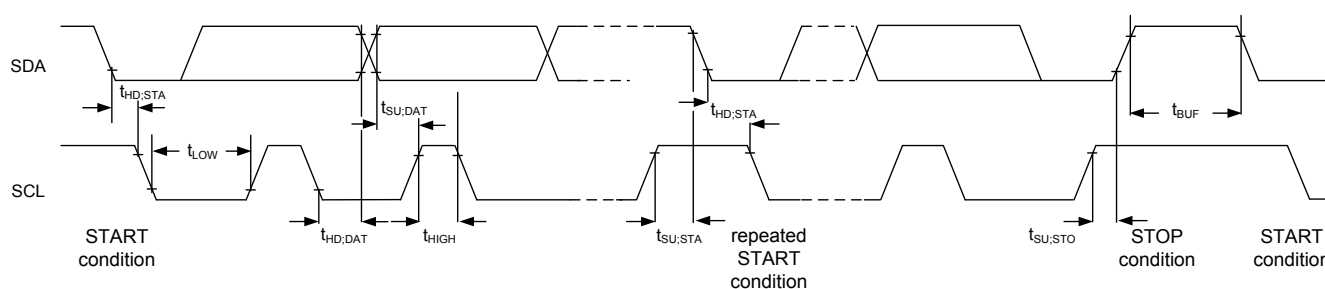
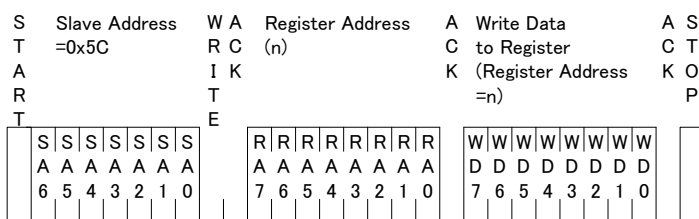


Figure 8. 2-wire Serial Bus Interface Timing Chart

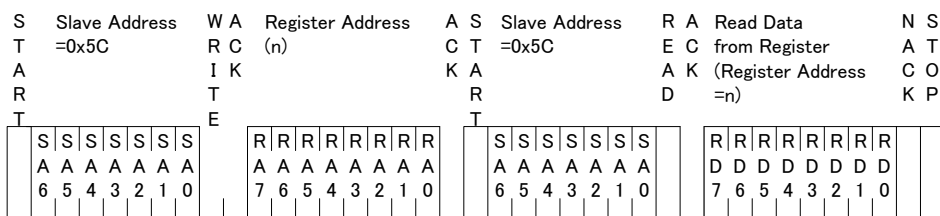
Parameter	Symbol	Standard-mode		Fast-mode		Unit
		Min	Max	Min	Max	
SCL Clock Frequency	$f_{SCL}$	0	100	0	400	kHz
Hold Time for ( Repeated ) START Condition	$t_{HD;STA}$	4.0	-	0.6	-	$\mu s$
Low Period of SCL	$t_{LOW}$	4.7	-	1.3	-	$\mu s$
High Period of SCL	$t_{HIGH}$	4.0	-	0.6	-	$\mu s$
Data Hold Time	$t_{HD;DAT}$	0.1	3.45	0.1	0.9	$\mu s$
Data Setup Time	$t_{SU;DAT}$	0.25	-	0.1	-	$\mu s$
Setup Time for Repeated Start Condition	$t_{SU;STA}$	4.7	-	0.6	-	$\mu s$
Setup Time for STOP Condition	$t_{SU;STO}$	4.0	-	0.6	-	$\mu s$
Bus Free Time Between STOP and START Condition	$t_{BUF}$	4.7	-	1.3	-	$\mu s$

## ●Byte Write



SA : Slave Address  
 RA : Register Address  
 RD : Read Data  
 WD : Write Data

## ●Random Read



## ●Sequential Read

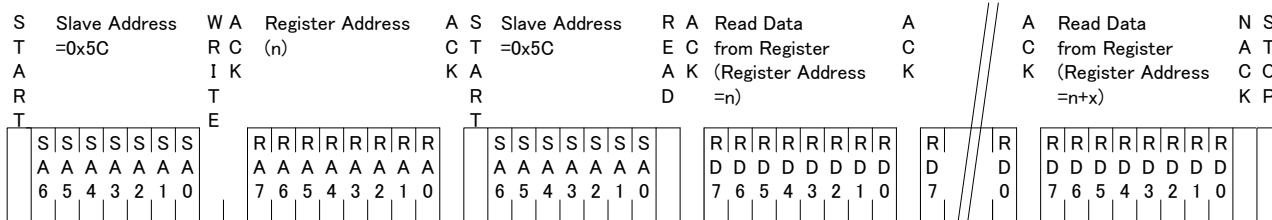


Figure 9. 2-wire Serial Bus Protocol

## Power on Sequence

The power supply pin is only VDD. AVDD and DVDD are generated by built-in LDO, these are not necessary to supply from external.

When the voltage level of RSTB change from low to High after VDD supplying, LDO is wakeup and DVDD voltage is raised. And built-in power on reset (POR) circuit release the system reset and host interface is enable After DVDD voltage reach the normal voltage range.

RSTB pin can not need to be controlled by host and connects to the VDD, because the BU21077MUV has POR circuit. If the RSTB pin is connected to the VDD, the system reset is release automatically after VDD supplying.

Recommended Value of External Capacitors

C <sub>1</sub>	1.0uF	Decoupling capacitor for VDD
C <sub>2</sub>	1.0uF	Decoupling capacitor for DVDD
C <sub>3</sub>	2.2uF	Decoupling capacitor for AVDD

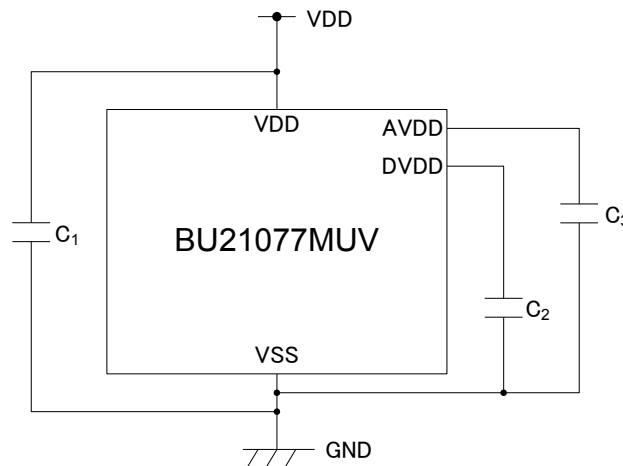


Figure 10. Arrangement of External Capacitors

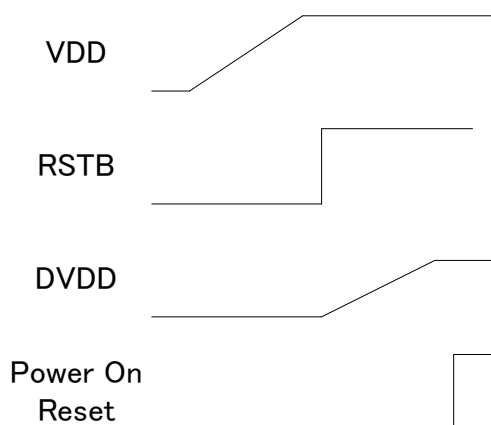


Figure 11. Power on Sequence (Controlled RSTB)

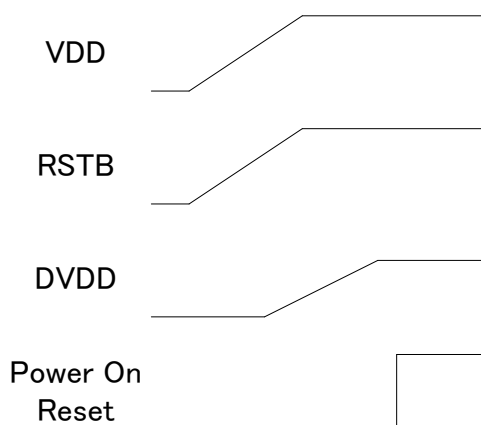


Figure 12. Power on Sequence (VDD Shorted RSTB)

## Operational Notes

### 1. Reverse Connection of Power Supply

Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply terminals.

### 2. Power Supply Lines

Design the PCB layout pattern to provide low impedance supply lines. Separate the ground and supply lines of the digital and analog blocks to prevent noise in the ground and supply lines of the digital block from affecting the analog block. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.

### 3. Ground Voltage

Ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition.

### 4. Ground Wiring Pattern

When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.

### 5. Thermal Consideration

Should by any chance the power dissipation rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. The absolute maximum rating of the Pd stated in this specification is when the IC is mounted on a 74.2mm x 74.2mm x 1.6mm glass epoxy board with 10.22mm<sup>2</sup> copper areas. In case of exceeding this absolute maximum rating, increase the board size and copper area to prevent exceeding the Pd rating.

### 6. Recommended Operating Conditions

These conditions represent a range within which the expected characteristics of the IC can be approximately obtained. The electrical characteristics are guaranteed under the conditions of each parameter.

### 7. Rush Current

When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.

### 8. Operation Under Strong Electromagnetic Field

Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.

### 9. Testing on Application Boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

### 10. Inter-pin Short and Mounting Errors

Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.



**Operational Notes – continued****11. Unused Input Terminals**

Input terminals of an IC are often connected to the gate of a MOS transistor. The gate has extremely high impedance and extremely low capacitance. If left unconnected, the electric field from the outside can easily charge it. The small charge acquired in this way is enough to produce a significant effect on the conduction through the transistor and cause unexpected operation of the IC. So unless otherwise specified, unused input terminals should be connected to the power supply or ground line.

**12. Regarding the Input Pin of the IC**

In the construction of this IC, P-N junctions are inevitably formed creating parasitic diodes or transistors. The operation of these parasitic elements can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions which cause these parasitic elements to operate, such as applying a voltage to an input pin lower than the ground voltage should be avoided. Furthermore, do not apply a voltage to the input terminals when no power supply voltage is applied to the IC. Even if the power supply voltage is applied, make sure that the input terminals have voltages within the values specified in the electrical characteristics of this IC.

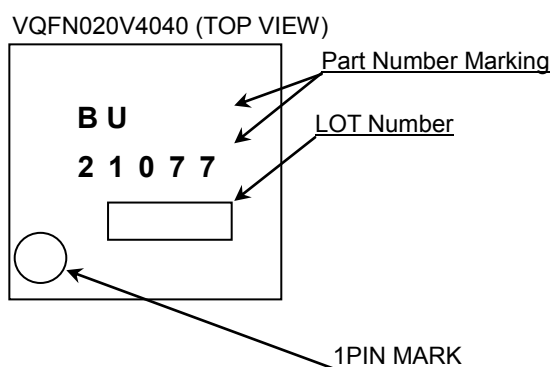
**13. Ceramic Capacitor**

When using a ceramic capacitor, determine the dielectric constant considering the change of capacitance with temperature and the decrease in nominal capacitance due to DC bias and others.

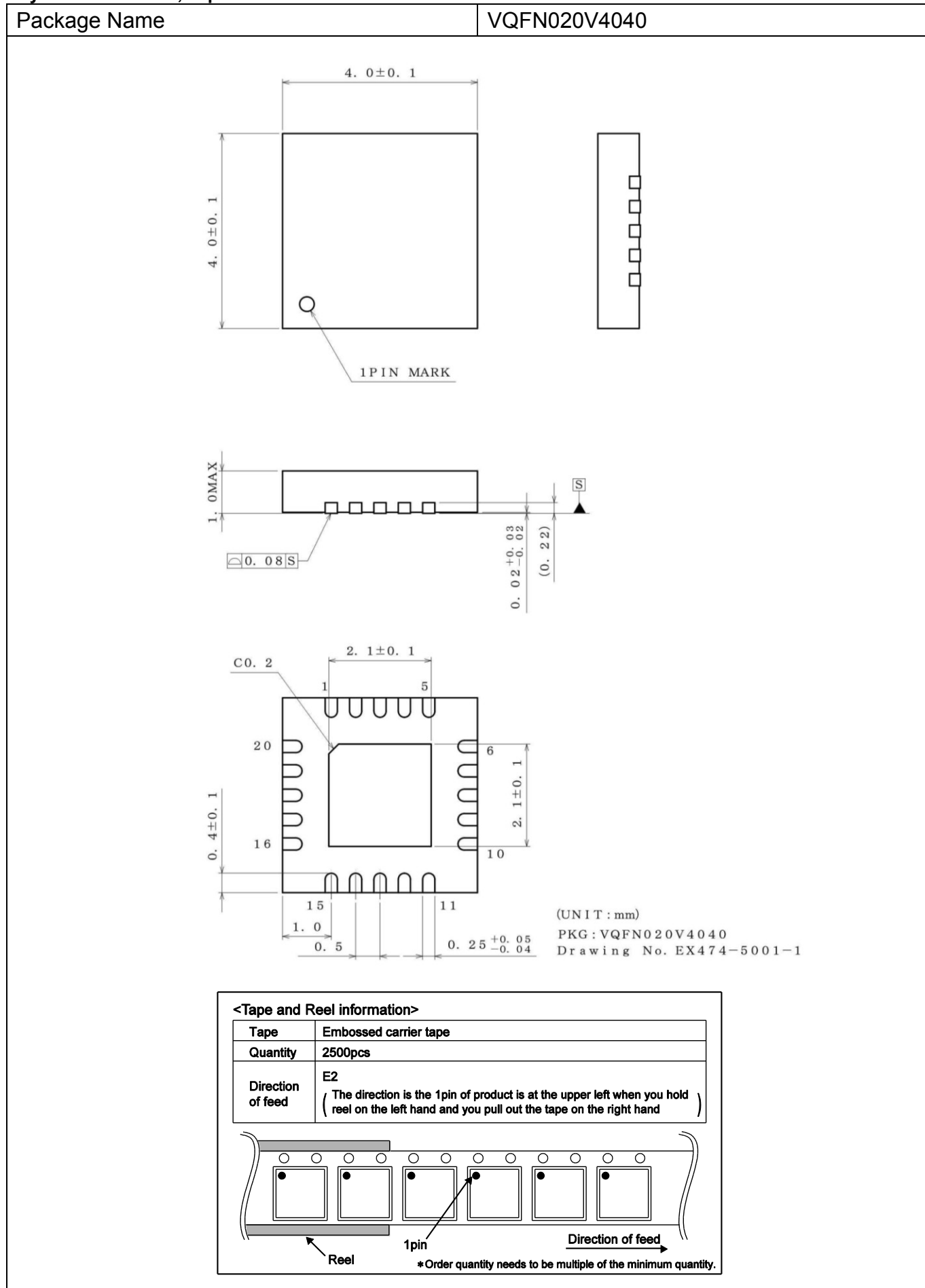
## Ordering Information

B U 2 1 0 7 7 M U V										-	E 2	
Part Number										Package MUV: VQFN020V4040		Packaging and forming specification E2: Embossed tape and reel

## Marking Diagram



## Physical Dimension, Tape and Reel Information



## Revision History

Date	Revision	Changes
29.Aug.2013	001	New Release
14.Jul.2016	002	P3 Correct clerical error (old) MUP (new) MPU  P7 Correct recommended value of decoupling capacitor for VDD (old) 0.1uF (new) 1.0uF

# Notice

## Precaution on using ROHM Products

- Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment <sup>(Note 1)</sup>, transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASS III	CLASS III	CLASS II b	CLASS III
CLASS IV		CLASS III	

- ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
  - Installation of protection circuits or other protective devices to improve system safety
  - Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc. prior to use, must be necessary:
  - Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - Sealing or coating our Products with resin or other coating materials
  - Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

## Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

## Precautions Regarding Application Examples and External Circuits

1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

## Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of ionizer, friction prevention and temperature / humidity control).

## Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

## Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

## Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

## Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

## Precaution Regarding Intellectual Property Rights

1. All information and data including but not limited to application example contained in this document is for reference only. ROHM does not warrant that foregoing information or data will not infringe any intellectual property rights or any other rights of any third party regarding such information or data.
2. ROHM shall not have any obligations where the claims, actions or demands arising from the combination of the Products with other articles such as components, circuits, systems or external equipment (including software).
3. No license, expressly or implied, is granted hereby under any intellectual property rights or other rights of ROHM or any third parties with respect to the Products or the information contained in this document. Provided, however, that ROHM will not assert its intellectual property rights or other rights against you or your customers to the extent necessary to manufacture or sell products containing the Products, subject to the terms and conditions herein.

## Other Precaution

1. This document may not be reprinted or reproduced, in whole or in part, without prior written consent of ROHM.
2. The Products may not be disassembled, converted, modified, reproduced or otherwise changed without prior written consent of ROHM.
3. In no event shall you use in any way whatsoever the Products and the related technical information contained in the Products or this document for any military purposes, including but not limited to, the development of mass-destruction weapons.
4. The proper names of companies or products described in this document are trademarks or registered trademarks of ROHM, its affiliated companies or third parties.

**General Precaution**

1. Before you use our Products, you are requested to carefully read this document and fully understand its contents. ROHM shall not be in any way responsible or liable for failure, malfunction or accident arising from the use of any ROHM's Products against warning, caution or note contained in this document.
2. All information contained in this document is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sales representative.
3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate and/or error-free. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[ROHM Semiconductor:](#)

[BU21077MUV-E2](#)



Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)

Email: [org@lifeelectronics.ru](mailto:org@lifeelectronics.ru)

[www.lifeelectronics.ru](http://www.lifeelectronics.ru)